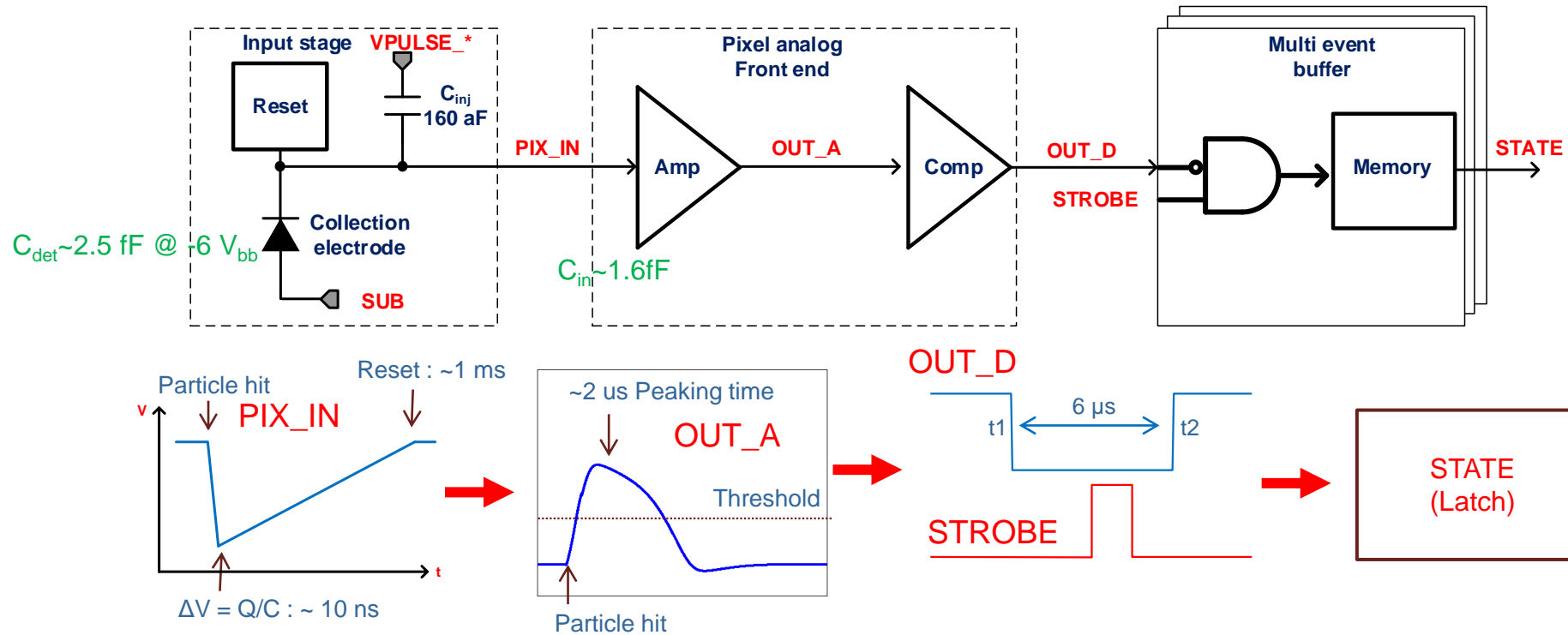


ePIC MAPS: Concept & Readout

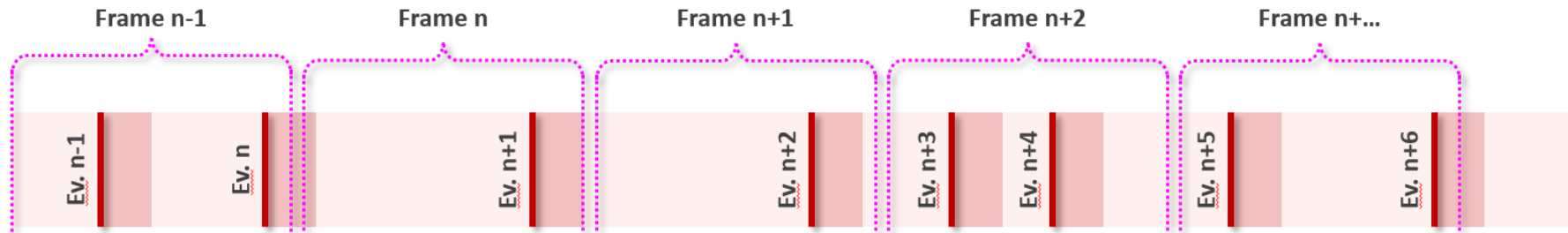
J. Schambach
ORNL

ORNL is managed by UT-Battelle LLC for the US Department of Energy

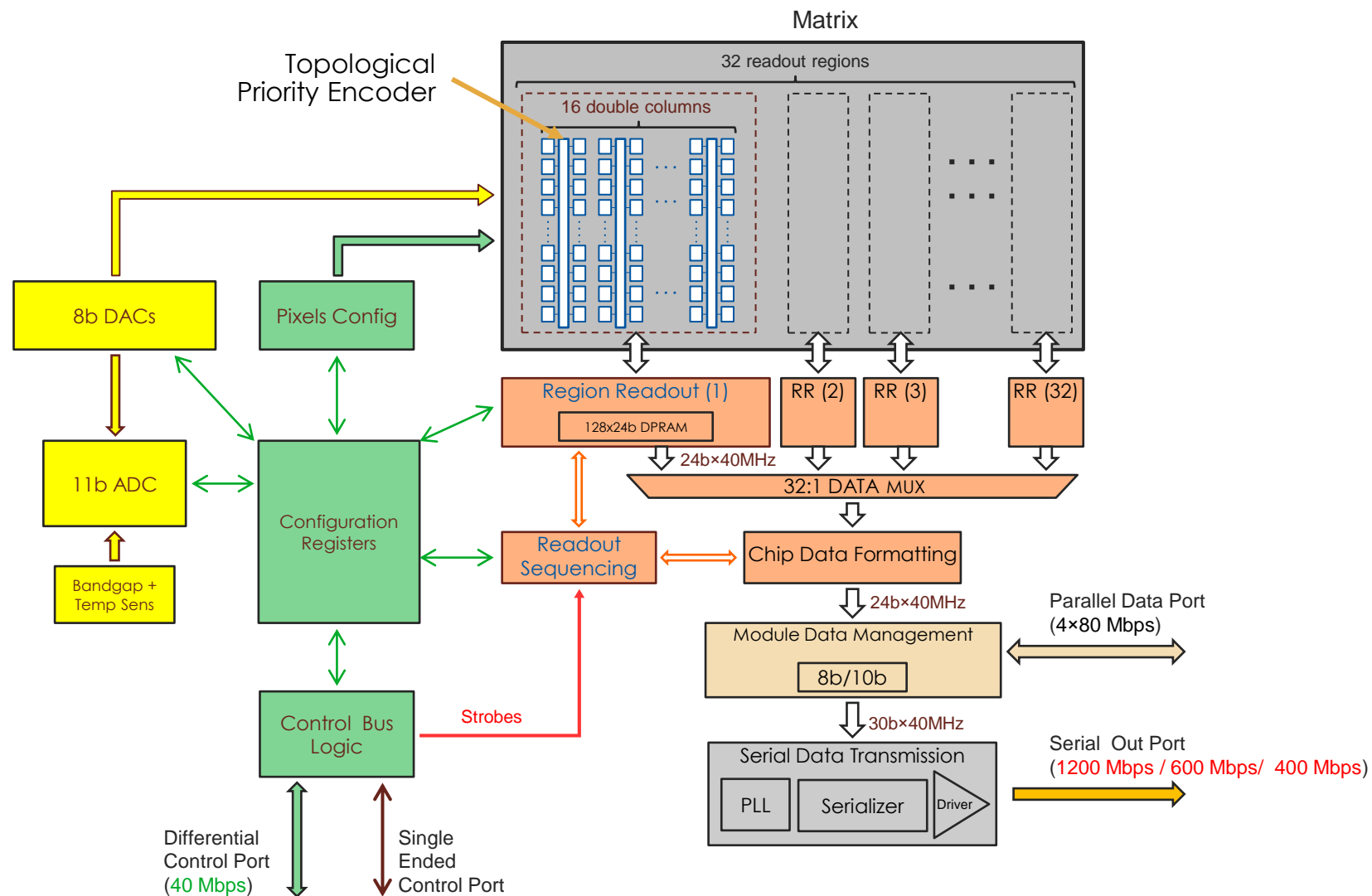
Reminder: ALPIDE Principle of Operation

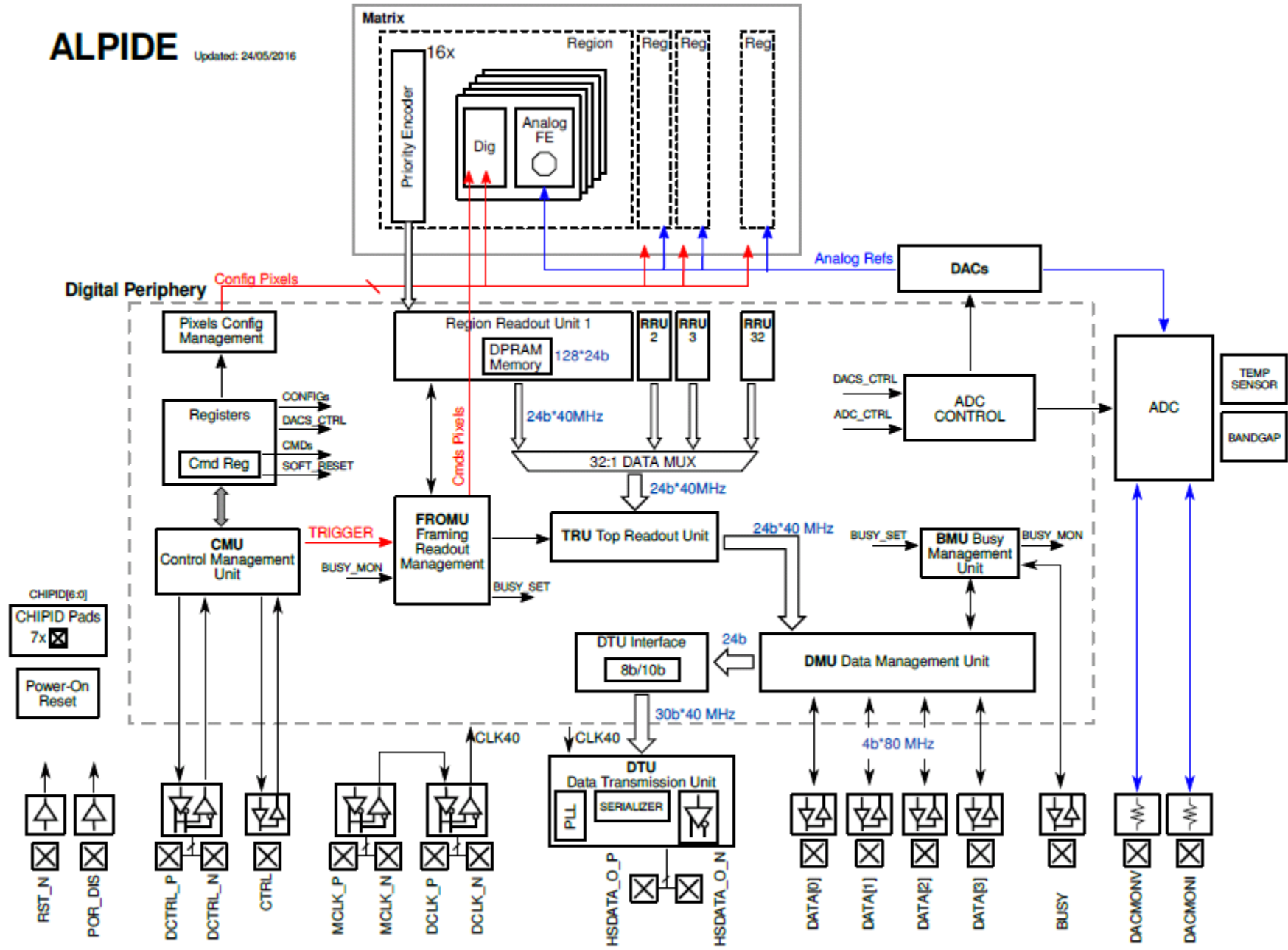


Continuous Mode: long “strokes” ($\sim 5\text{-}20\mu\text{s}$), followed by short inter-stroke periods (100 ns) for readout



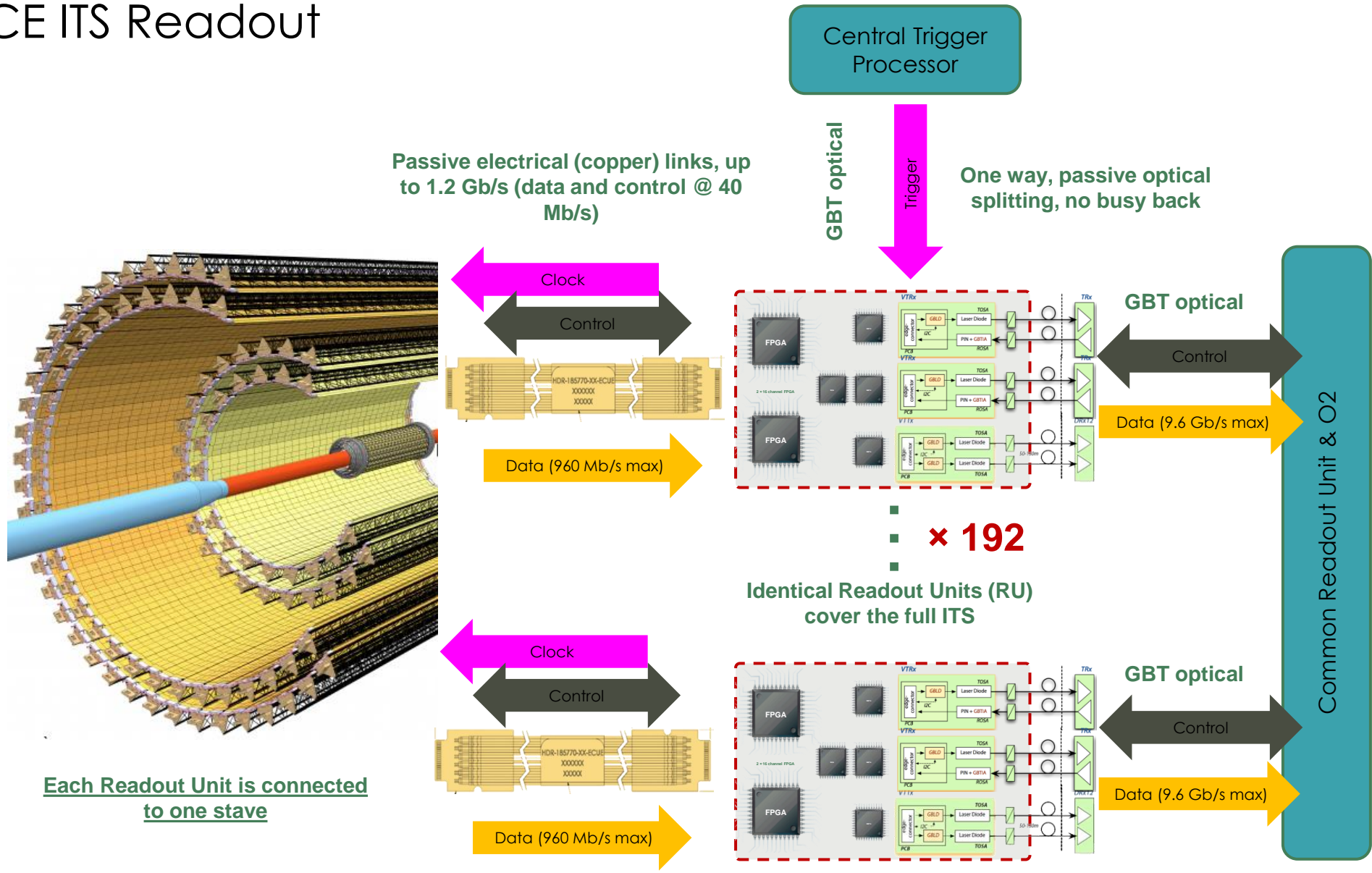
ALPIDE Readout Block Diagram





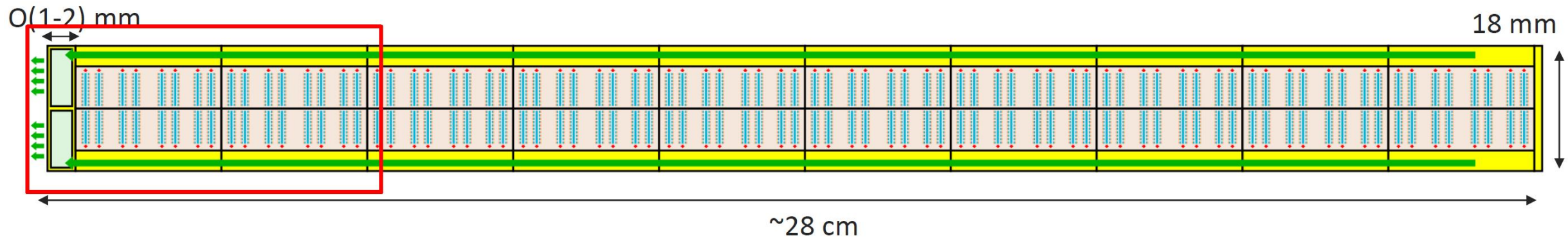
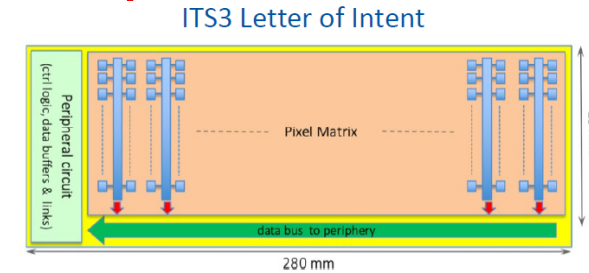
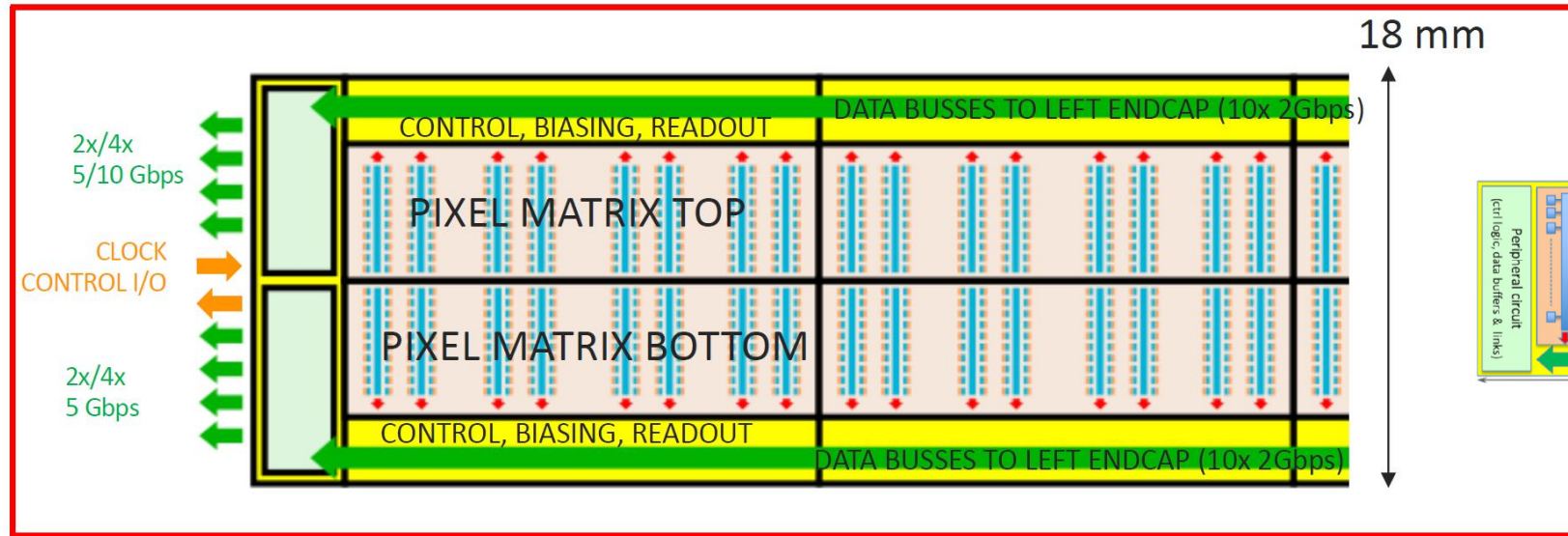
ALICE ITS Readout

No FEB



Stitched backbone busses and fast serial outputs

ITS-3

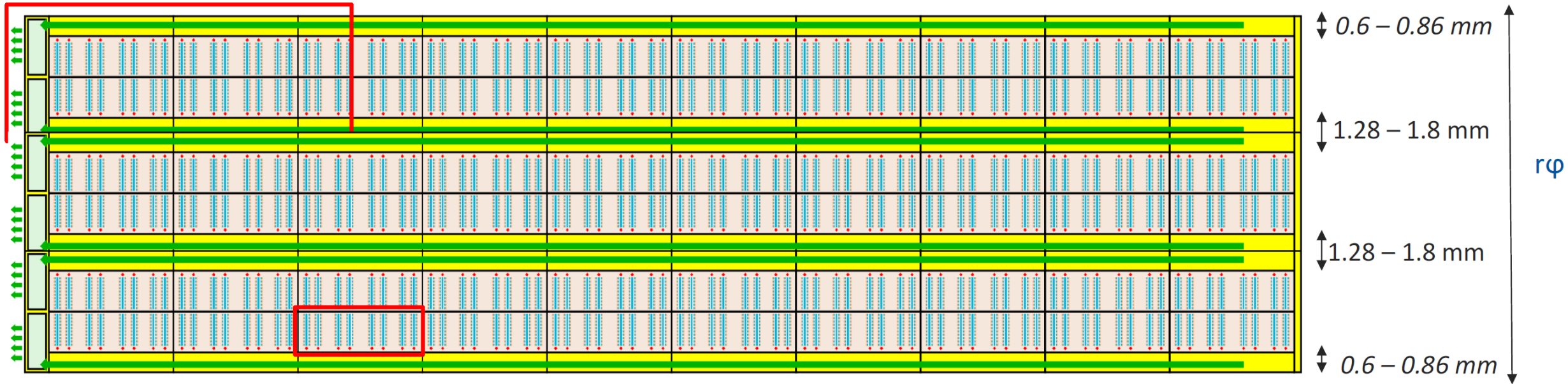


Half Layer 0



z
~27 cm

$R_0 * \pi = 56.5$ mm



60 Sensitive Units

Non sensitive peripheral regions:

3.76 – 5.32 mm

6.7% – 9.5%

Remark on timing

Projections for timing resolution

Targeting figures similar to ALPIDE

Continuous mode readout

Integration period: 5 / 10 / 20 μs

Frame rate: 200 / 100 / 50 kHz

Low power constrains response speed

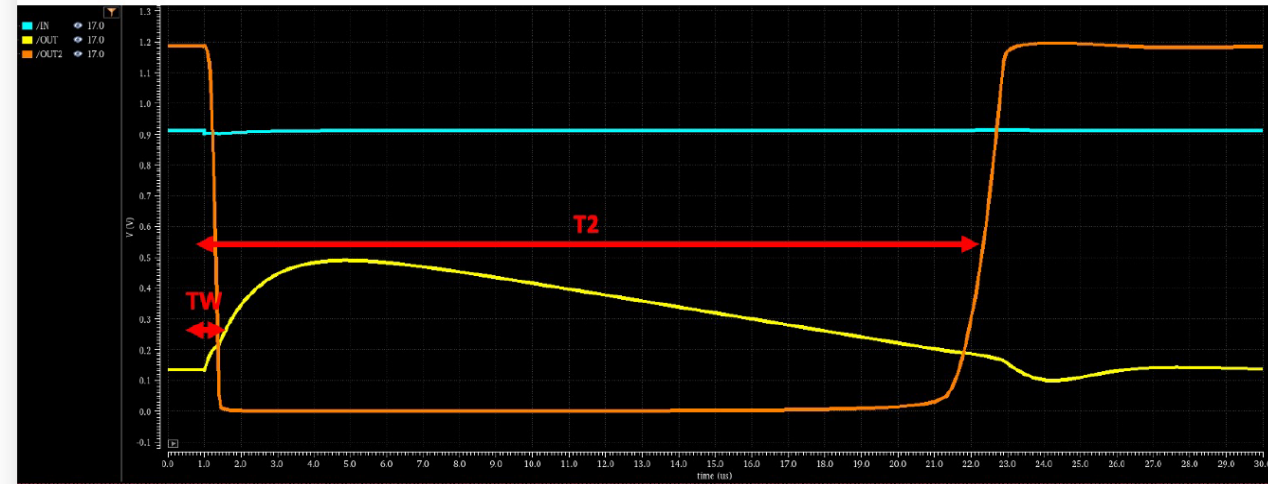
MOSS pulse duration 40 μs @ 1 ke

MOSS time walk $\sim 3.3 \mu\text{s}$

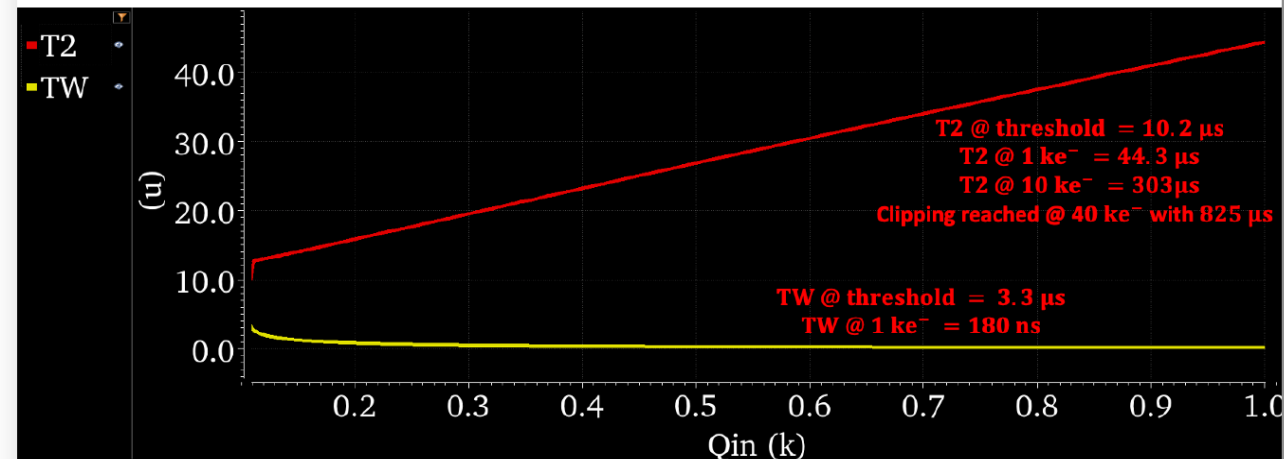
Reviewing timing specs for next design

Discriminator time window

(MOSS, nominal bias for low power)

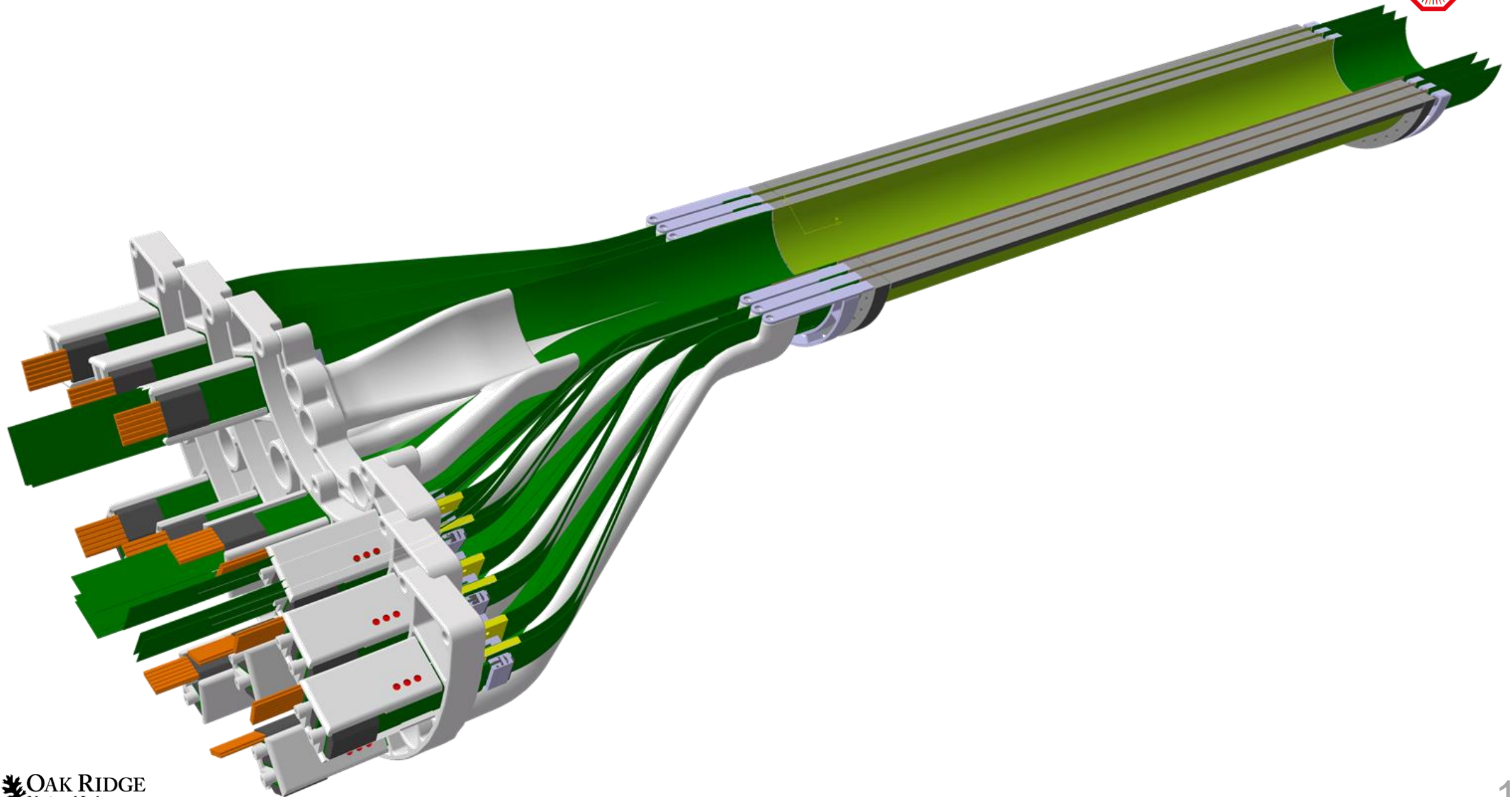


Discriminator time window



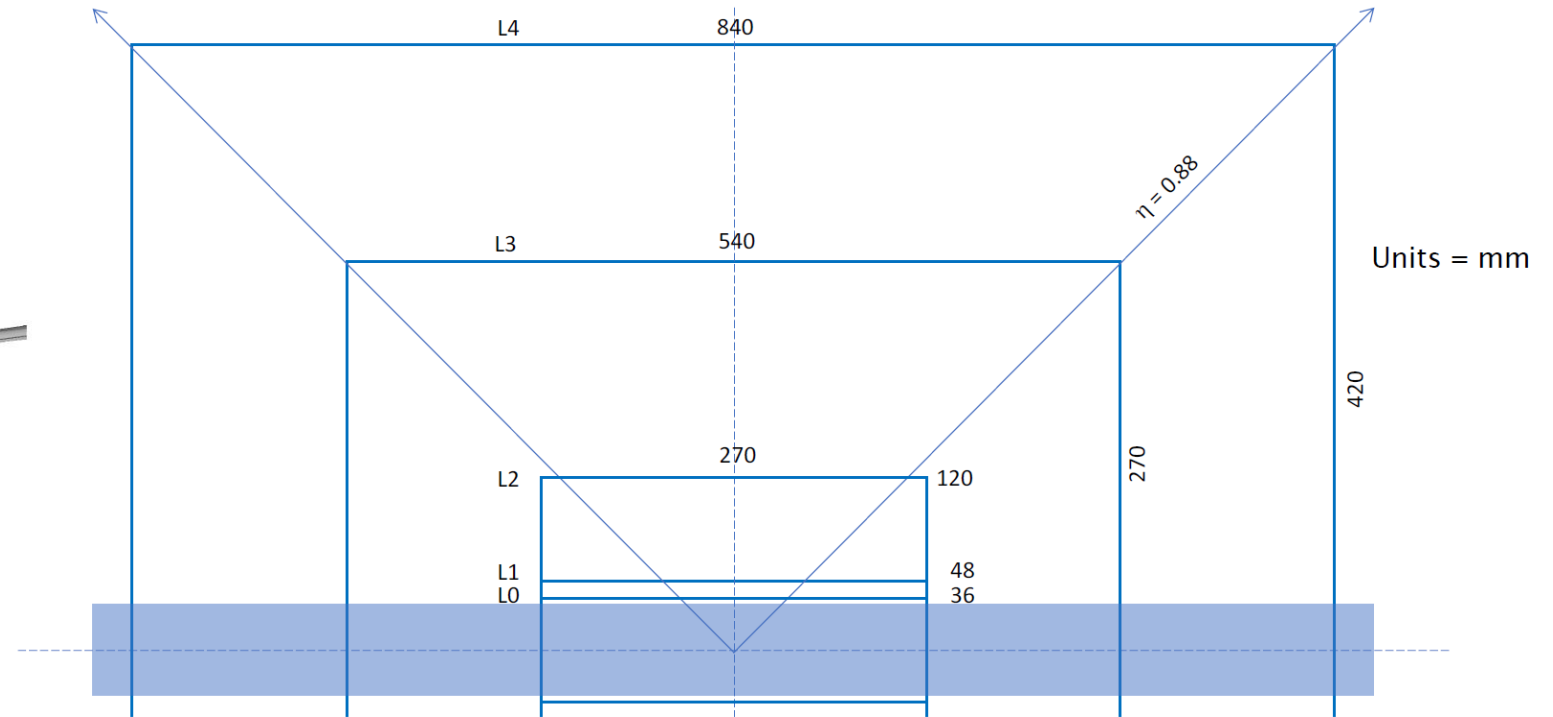
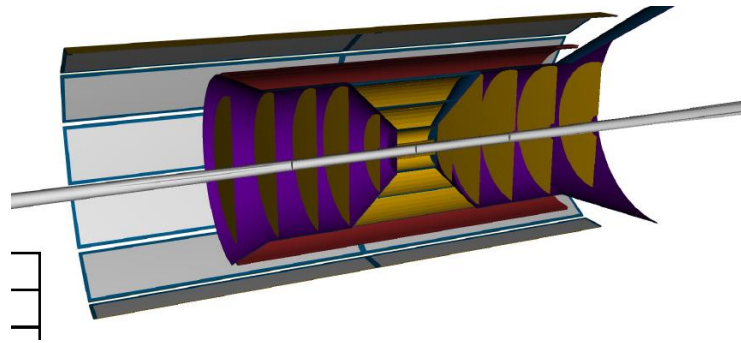
A few private remarks from one of the ITS-3 chip designers

- Overall readout scheme considered for ITS-3 similar to ALPIDE
 - Global strobe signal, in-pixel latching logic, transfer of hits using topological priority encoder
 - In-pixel memory not yet defined
 - Looking into latching the discriminated hit using rising edge of discriminator in coincidence with strobe assertion
- Strobe programmability will be 1 us \rightarrow 100 us, duration from $O(200\text{ns})$ to the period
- Considering time-walk and readout scheme, best achievable timing resolution $O(3\mu\text{s})$ for ITS-3
- No sophisticated clustering or other processing, likely only similar to ALPIDE combining neighboring pixels in readout
- Don't see a path to significantly improved timing resolution in ITS3 vs ALPIDE without relaxing power constraints, area constraints, and granularity
 - Intrinsic pixel sensor timing resolution OK, but collection, maintaining, and transmission at far distances not possible to reach anywhere near 100ns for very large arrays of small pixels; seen as a system design problem
 - Doubtful to achieve a gain of 1-2 orders of magnitude in timing without orders of magnitude more power and a good fraction of non-sensitive areas on the chips



EPIC Vertex and Sagitta Layers

Note: these are active lengths; they do not include the periphery



L0, L1 and L2 lengths are **single** sensors that are **270 mm** long (9 reticles)

L3 length can be achieved using **two** sensors **270 mm** long (9 reticles), or **three** sensors **180 mm** long (6 reticles)
Choice of two or three sensors may be decided by sensor yield

L4 length can be achieved using **four** sensors **210 mm** long (7 reticles)

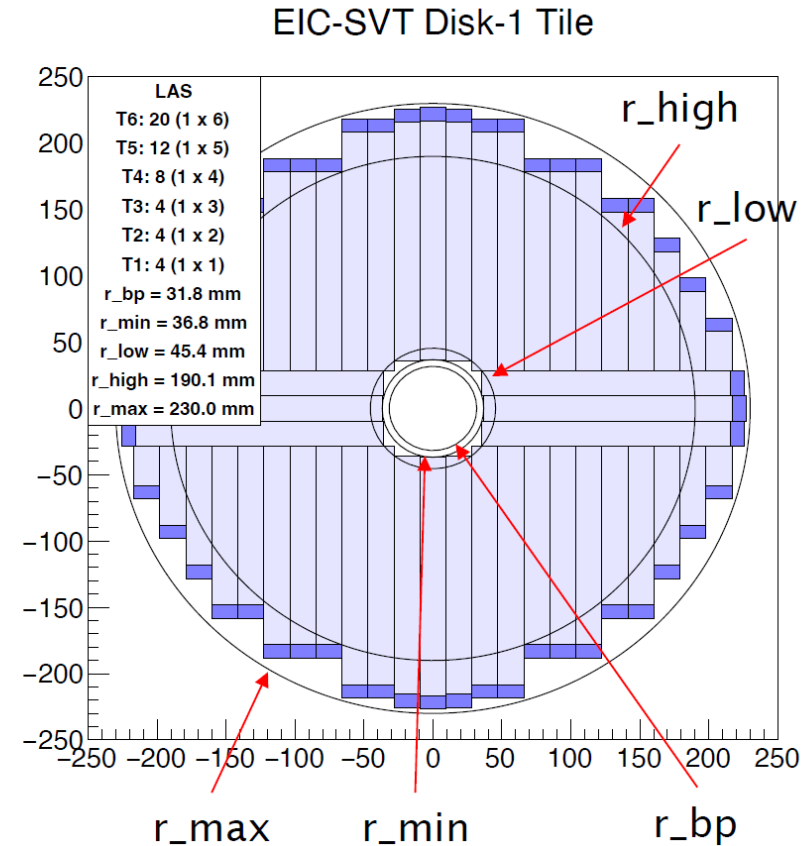
Disk Tiling

- More details on the disks tiling study and methods in the backup and here <https://indico.bnl.gov/event/17073/>

r_{bp} = beam pipe radius
 r_{min} = $r_{bp} + 5$ mm
 r_{max} = outer disk radius
 r_{low} = smallest radius with full acceptance
 r_{high} = largest radius with full acceptance

TX: YY (1 x X) → on the disk there are YY Tiles made of one stitched row of X reticules.

Example: T5: 12 (1x5) → on the disk there are 12 tiles made of one stitched row of 5 reticules (i.e. 18.85 mm x 150 mm).



ePIC MAPS Detector

Barrel				Sensor											# pixels	# sensors	Mechanical	# Readout Links		
Layer Index	radius (mm)	z (mm)	Area (mm ²)	reticles in width	reticles in length	# of sensors in r-phi	# of sensors in z													
0	36	270	61,074	3	9	4	1										271,440,000	4	bent ITS3	96
1	48	270	81,432	4	9	4	1										361,920,000	4	bent ITS3	128
2	120	270	203,580	5	9	8	1										904,800,000	8	bent ITS3	320
3	268.4	540	1,017,900	1	9	100	2										4,524,000,000	200	stave	1600
4	418.5	840	2,470,104	1	7	156	4										10,978,240,000	624	stave	624
				LAS	T1	T2	T3	T4	T5	T6	T7	T8	T9							
				# of reticles	1	2	3	4	5	6	7	8	9							
e-endcap																				
Disk index	z (mm)	inner r (mm)	outer r (mm)																	
1	-250	36.76	230	133,458	4	4	4	8	12	20	0	0	0	593,146,667	52	stave	52			
2	-450	36.76	430	506,688	0	0	0	60	4	12	20	44	8	2,251,946,667	148	stave	148			
3	-650	36.76	430	506,688	0	0	0	60	4	12	20	44	8	2,251,946,667	148	stave	148			
4	-900	40.0614	430	507,819	0	0	0	62	4	16	18	42	8	2,256,973,333	150	stave	150			
5	-1150	46.3529	430	505,557	0	0	0	64	2	16	20	40	8	2,246,920,000	150	stave	150			
h-endcap																				
Disk index																				
1	250	36.76	190	133,458	4	4	4	8	12	20	0	0	0	593,146,667	52	stave	52			
2	450	36.76	430	506,688	0	0	0	60	4	12	20	44	8	2,251,946,667	148	stave	148			
3	700	38.52	430	505,557	0	0	0	62	2	12	20	44	8	2,246,920,000	148	stave	148			
4	1000	53.43	430	503,295	0	0	0	64	4	14	20	42	6	2,236,866,667	150	stave	150			
5	1350	70.14	530	506,688	0	0	0	62	4	14	24	38	8	2,251,946,667	150	stave	150			
TOTAL				8,149,986											36,222,160,000	2136			4064	

Pixel Size: 15µm
 Reticle Size: 18.85 x 30 mm²
 ~2.5 GPixel

Readout Thoughts

N. Schmidt's Simulations:

Detector	Average # hits in min. bias pythia6 (10x100 GeV)	Average # hits in High Q2 pythia6 (18x275 GeV)
Full barrel (3 vertex + 2 sagitta)	9.3	30.7
Full forward (5 disks)	16.8	36.3
Full backward (4 disks)	6.4	2.2
Barrel layers (0/1/2/3/4)	2.4 / 1.7 / 1.4 / 1.9 / 1.8	7.2 / 5.8 / 4.9 / 6.6 / 6.2

- Adding these numbers, the total number of hits (vertex, sagitta, forward/backward disks) would have around **70** hits. Latest results from DPTS show about 1.2 pixels firing per hit, but no study has yet been done how that changes with incident angle. This would result in about **85 pixels** with data. Let's assume the background is about the same size, i.e., a total number of **170 pixels per event**. How much should we assume for the angle effect?
- An assumed collision rate of **500 kHz** would then result in a "Physics" pixel rate of **85 Mega-pixels per second**.
- From recent **DPTS fake hit rate** results, it seems that the current MLR1 prototype sensors have a noise rate of about **10⁻² pixel⁻¹ sec⁻¹** (corresponding to 10⁻⁷ pixel⁻¹ event⁻¹ for ALPIDE). For a total number of **36 B** pixels in ePIC, this would result in a total of **310 Mega-pixels per second** fired just from noise.
- Adding "Physics" and "Noise" together we need to read out **~400 Mpixels/sec**. So far there are no thoughts yet on the data format out of an ITS-3 sensor, it will probably look very similar to the format from ALPIDE, i.e., region headers followed by double column addresses, followed by (clustered) matrix addresses of hit pixels. Let's assume for simplicity **64 bits per pixel**. This results in a total data rate of **25.6 Gbps**, not very much compared to a fiber rate of similar capability for the new Phase-2 FELIX fiber links. Whatever Readout Unit would be developed for ePIC MAPS would mainly be concerned with aggregation of multiple copper links, removing empty frames, and transmission over 10 or 25 Gbps fiber links.

... next slide ...

Readout Thoughts (continued)

- The range of transmission in ITS2 from the staves to the Readout Units is about **8m** at **1.2 Gbps**. Studies by M. Rossevij with the Samtec firefly cables used in ITS-2 show that transmission at that speed already needs proper pre-emphasis and equalization, and that the BER eye closes fully at ~3Gbps. For 5 Gbps transmission lines it seems that an **active repeater** is needed at ~1m from the edge of the flex. In case of ITS3 these would be in the service cone, i.e., not in the active region of the ALICE detector. Where would we be able to place such repeaters in ePIC?
- For ITS-3 the line drivers will likely not be configurable for speed, since the layers in ITS-3 are very close and thus need the same rate capabilities, but some configurability (be it the line rate or how many are actually activated and used) might be envisaged (according to Gianluca), still to be determined in the future.
- Where would we be able to place the above-mentioned Readout Boards? How far would that be from the edge of the flex cables from the sensors?
- A possible means of reduction of the required links out of the MAPS barrel region would be to use a rad-hard FPGA board to multiplex copper links for up and downstream into one or more fibers (combined into a fiber bundle like an MTP assembly) close to the flex circuit of the sensor. Possible candidates for FPGA and fiber converters were identified in earlier work in eRD104: **Microsemi PolarFire** FPGA, and **Samtec optical FireFly**. Rad-tolerance might require use of the **VTRx+** fiber assembly from the lpGBT development (possible use of the lpGBT ASIC as well?) instead of Samtec optical FireFly. Questions: Would it perhaps be possible to incorporate such circuitry into the flex circuit of the sensor? If not, where would such a PCB be possible to place (close to the flex)?
- In ITS we were able to accommodate up to 28 copper links per Readout Unit. For ePIC this aggregation would depend on the number of transceivers available on the FPGA chosen for the RDO board. A (cheap) candidate is the **Xilinx Artix UltraScale+** FPGA family (~\$250 for the XCAU10P) which has up to twelve 12.5 Gbps transceivers. Assuming 10 links for copper, and 1 link for fiber, this would mean one would need ~**400 RDO boards** (corresponding to **400 12.5 Gbps fibers**). Each FELIX will likely have up to 48 fiber links. The whole MAPS detector would then need **10 FELIX boards**.